



Title of Change:	Moisture Sensitivity Level (MSL) rating conversion of NCP1611 device family from MSL3 to MSL2.		
Effective date:	20 September 2017		
Contact information:	Contact your local ON Semiconductor Sales Office or < Jiri.Konarik@onsemi.com >		
Type of notification:	ON Semiconductor will consider this change accepted.		
Change category:	<input type="checkbox"/> Wafer Fab Change <input type="checkbox"/> Assembly Change <input type="checkbox"/> Test Change <input checked="" type="checkbox"/> Other - <u>Packaging/Labeling</u>		
Change Sub-Category(s):	<input type="checkbox"/> Manufacturing Site Change/Addition <input type="checkbox"/> Manufacturing Process Change	<input type="checkbox"/> Material Change <input type="checkbox"/> Product specific change	<input type="checkbox"/> Datasheet/Product Doc change <input checked="" type="checkbox"/> Shipping/ <u>Packaging</u> /Marking <input type="checkbox"/> Other: _____
Sites Affected:	<input type="checkbox"/> All site(s) <input type="checkbox"/> not applicable	<input checked="" type="checkbox"/> ON Semiconductor site(s) : ON Carmona, Philippines	<input type="checkbox"/> External Foundry/Subcon site(s)
Description and Purpose:			
<p>The Product Bulletin is to notify customer that the Moisture Sensitivity Level (MSL) rating for NCP1611ADR2G and NCP1611BDR2G products, in our SOIC-8 package, will be updated from MSL3/260 to MSL2/260.</p> <p>There is no change in the BOM or packaging, only the label will change to indicate an MSL2 rating.</p> <p>Effective 15-September-2017 the label will change from MSL3/260 to MSL2/260.</p> <p>The reliability report qualifying this change is available upon request. Please send your request to <Jiri.Konarik@onsemi.com> to receive a copy.</p>			
List of Affected Standard Parts:			
NCP1611ADR2G NCP1611BDR2G			